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Kind regards,

Team Nexperia

## 74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset

Rev. 3 — 4 January 2017

**Product data sheet** 

### 1. General description

The 74HC161 is a synchronous presettable binary counter with an internal look-head carry. Synchronous operation is provided by having all flip-flops clocked simultaneously on the positive-going edge of the clock (CP). The outputs (Q0 to Q3) of the counters may be preset HIGH or LOW. A LOW at the parallel enable input (PE) disables the counting action and causes the data at the data inputs (D0 to D3) to be loaded into the counter on the positive-going edge of the clock. Preset takes place regardless of the levels at count enable inputs (CEP and CET). A LOW at the master reset input (MR) sets Q0 to Q3 LOW regardless of the levels at input pins CP, PE, CET and CEP (thus providing an asynchronous clear function). The look-ahead carry simplifies serial cascading of the counters. Both CEP and CET must be HIGH to count. The CET input is fed forward to enable the terminal count output (TC). The TC output thus enabled will produce a HIGH output pulse of a duration approximately equal to a HIGH output of Q0. This pulse can be used to enable the next cascaded stage. The maximum clock frequency for the cascaded counters is determined by the CP to TC propagation delay and CEP to CP set-up time, according to the following formula:

$$f_{max} = \frac{I}{t_{P(max)}(CPtoTC) + t_{SU}(CEPtoCP)}$$

Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{\text{CC}}.$ 

### 2. Features and benefits

- Complies with JEDEC standard no. 7A
- Input levels:
  - For 74HC161: CMOS level
- Synchronous counting and loading
- 2 count enable inputs for n-bit cascading
- Asynchronous reset
- Positive-edge triggered clock
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from –40 °C to +85 °C and –40 °C to +125 °C

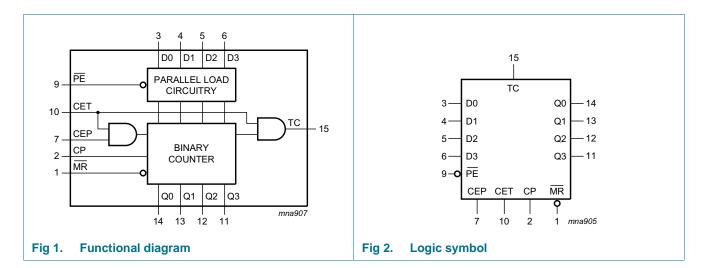


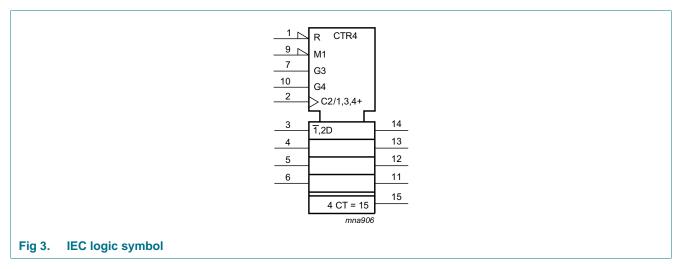
#### **Ordering information** 3.

#### **Ordering information** Table 1.

Type number	Package								
	Temperature range	Name	Description	Version					
74HC161D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74HC161DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1					
74HC161PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					

#### **Functional diagram** 4.

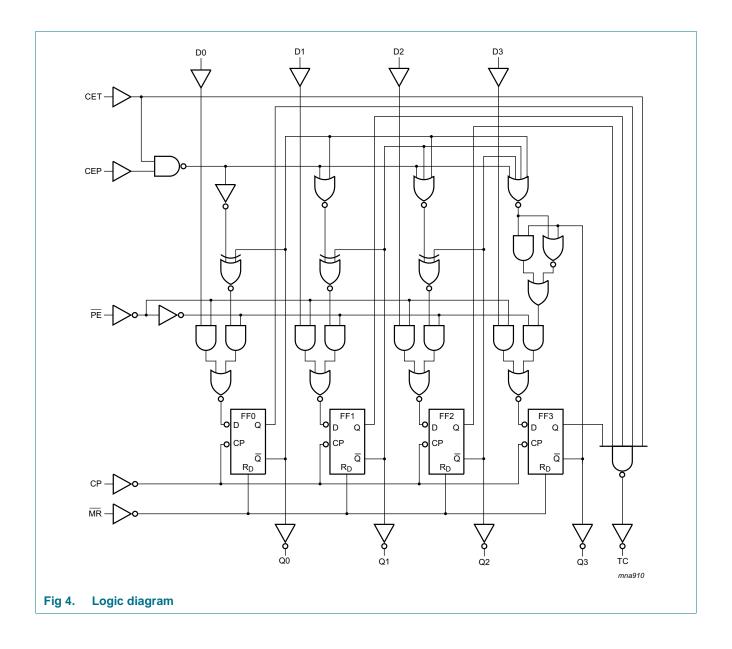




74HC161 **Product data sheet** 

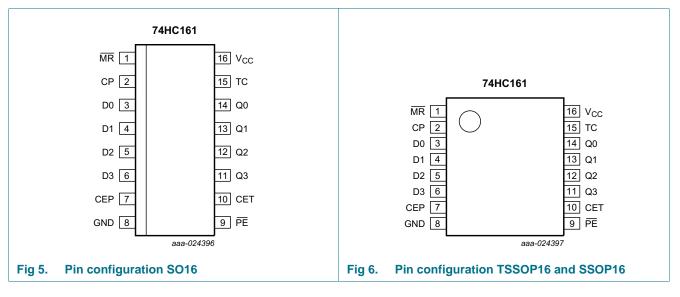
## 74HC161

### Presettable synchronous 4-bit binary counter; asynchronous reset



### 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

### Table 2. Pin description

Symbol	Pin	Description
MR	1	asynchronous master reset (active LOW)
СР	2	clock input (LOW-to-HIGH, edge-triggered)
D0, D1, D2, D3	3, 4, 5, 6	data input
CEP	7	count enable input
GND	8	ground (0 V)
PE	9	parallel enable input (active LOW)
CET	10	count enable carry input
Q0, Q1, Q2, Q3	14, 13, 12, 11	flip-flop output
TC	15	terminal count output
V <sub>CC</sub>	16	supply voltage

### 6. Functional description

### Table 3. Function table<sup>[1]</sup>

Operating	Input		Output	Output				
modes	MR	СР	CEP	CET	PE	Dn	Qn	тс
Reset (clear)	L	Х	Х	Х	Х	Х	L	L
Parallel load	Н	$\uparrow$	Х	Х	I	I	L	L
	Н	$\uparrow$	Х	Х	I	h	Н	[2]
Count	Н	$\uparrow$	h	h	h	Х	count	[2]
Hold	Н	Х	I	Х	h	Х	q <sub>n</sub>	[2]
(do nothing)	Н	Х	Х	I	h	Х	q <sub>n</sub>	L

[1] H = HIGH voltage level

 $\mathsf{h}=\mathsf{HIGH}$  voltage level one set-up time prior to the LOW-to-HIGH clock transition

L = LOW voltage level

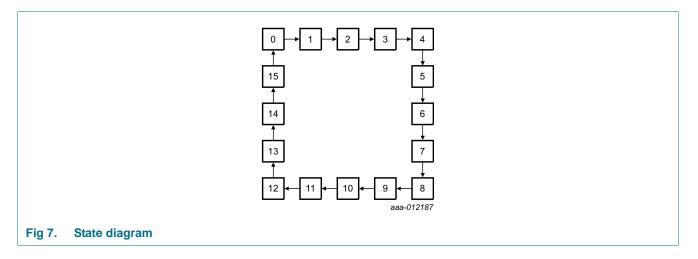
I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition

 $q_n$  = lower case letters indicate the state of the referenced output one set-up time prior to the LOW-to-HIGH clock transition

X = don't care

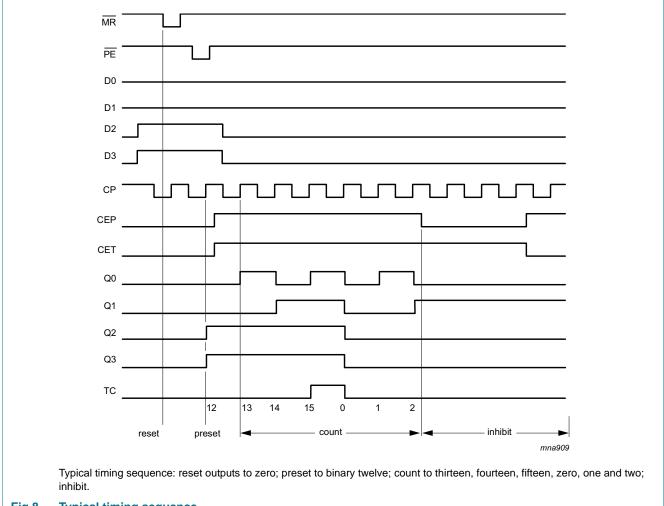
 $\uparrow$  = LOW-to-HIGH clock transition

[2] The TC output is HIGH when CET is HIGH and the counter is at terminal count (HHHH)



## 74HC161

### Presettable synchronous 4-bit binary counter; asynchronous reset



### Fig 8. Typical timing sequence

### 7. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7.0	V
l <sub>IK</sub>	input clamping current	$V_{I} < -0.5$ V or $V_{I} > V_{CC} + 0.5$ V		-	±20	mA
I <sub>ОК</sub>	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V		-	±20	mA
lo	output current	$V_{O} = -0.5$ V to $V_{CC}$ + 0.5 V		-	±25	mA
I <sub>CC</sub>	supply current			-	50	mA
I <sub>GND</sub>	ground current			-50	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	SO16 package	<u>[1]</u>	-	500	mW
		(T)SSOP16 package	<u>[1]</u>	-	500	mW

[1] For SO16 packages: above 70 °C the value of  $P_{tot}$  derates linearly at 8 mW/K.

For (T)SSOP16 packages: above 60 °C the value of P<sub>tot</sub> derates linearly at 5.5 mW/K.

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### 8. Recommended operating conditions

### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	ns/V

### 9. Static characteristics

### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	-
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	IL LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0; V_{CC} = 4.5 V$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2; V_{CC} = 6.0 V$	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_0 = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I <sub>CC</sub>	supply current		-	-	8.0	-	80.0	-	160.0	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

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### **10. Dynamic characteristics**

### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see <u>Figure 14</u>.

Symbol	Parameter	Conditions		25 °C		-40 °C to	+85 °C	–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
t <sub>pd</sub>	propagation	CP to Qn; see Figure 9 [1]								
	delay	V <sub>CC</sub> = 2.0 V	-	61	190	-	240	-	285	ns
		V <sub>CC</sub> = 4.5 V	-	22	38	-	48	-	57	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	19	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	18	32	-	41	-	48	ns
		CP to TC; see Figure 9								
		V <sub>CC</sub> = 2.0 V	-	69	215	-	270	-	325	ns
		V <sub>CC</sub> = 4.5 V	-	25	43	-	54	-	65	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	21	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	20	37	-	46	-	55	ns
		CET to TC; see Figure 10								
		V <sub>CC</sub> = 2.0 V	-	33	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V	-	12	30	-	38	-	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	10	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	10	26	-	38	-	31	ns
t <sub>PHL</sub>	HIGH to	MR to Qn; see Figure 11								
	LOW propagation	V <sub>CC</sub> = 2.0 V	-	63	210	-	265	-	315	ns
	delay	V <sub>CC</sub> = 4.5 V	-	23	42	-	53	-	63	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	18	36	-	45	-	54	ns
		MR to TC; see Figure 11								
		$V_{CC} = 2.0 V$	-	63	220	-	275	-	330	ns
		V <sub>CC</sub> = 4.5 V	-	23	44	-	55	-	66	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	18	37	-	47	-	56	ns
t <sub>t</sub>	transition	see Figure 9 and Figure 10 [2]								
	time	V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns

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Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Мах	-
t <sub>W</sub>	pulse width	CP; HIGH or LOW; see Figure 9								
		V <sub>CC</sub> = 2.0 V	80	22	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	8	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns
		MR; LOW; see Figure 11								
		V <sub>CC</sub> = 2.0 V	80	19	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	7	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns
t <sub>rec</sub> recovery time	MR to CP; see Figure 11									
	time	V <sub>CC</sub> = 2.0 V	100	19	-	125	-	150	-	ns
		V <sub>CC</sub> = 4.5 V	20	7	-	25	-	30	-	ns
		V <sub>CC</sub> = 6.0 V	17	6	-	21	-	26	-	ns
t <sub>su</sub>	set-up time	Dn to CP; see Figure 12								
		V <sub>CC</sub> = 2.0 V	80	25	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	9	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	7	-	17	-	20	-	ns
		PE to CP; see Figure 12								
		V <sub>CC</sub> = 2.0 V	100	30	-	125	-	150	-	ns
		V <sub>CC</sub> = 4.5 V	20	11	-	25	-	30	-	ns
		V <sub>CC</sub> = 6.0 V	17	9	-	21	-	26	-	ns
		CEP, CET to CP; see Figure 13								
		V <sub>CC</sub> = 2.0 V	170	47	-	215	-	255	-	ns
		V <sub>CC</sub> = 4.5 V	34	17	-	43	-	51	-	ns
		V <sub>CC</sub> = 6.0 V	29	14	-	37	-	43	-	ns
t <sub>h</sub>	hold time	Dn, PE, CEP, CET to CP; see Figure 12 and Figure 13								
		V <sub>CC</sub> = 2.0 V	0	-14	-	0	-	0	-	ns
		V <sub>CC</sub> = 4.5 V	0	-5	-	0	-	0	-	ns
		V <sub>CC</sub> = 6.0 V	0	-4	-	0	-	0	-	ns
f <sub>max</sub>	maximum	CP; see Figure 9								
	frequency	V <sub>CC</sub> = 2.0 V	4.6	13	-	3.6	-	3.0	-	MHz
		V <sub>CC</sub> = 4.5 V	23	40	-	18	-	15	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	44	-	-	-	-	-	MHz
		V <sub>CC</sub> = 6.0 V	27	48	-	21	-	18	-	MHz

### Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 14.

### Presettable synchronous 4-bit binary counter; asynchronous reset

#### Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 14.

Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
C <sub>PD</sub>	power dissipation capacitance	$V_1 = GND$ to $V_{CC}$ ; $V_{CC} = 5 V$ ; $f_i = 1 MHz$	-	33	-	-	-	-	-	pF

[1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .

[2]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W):

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i = input frequency in MHz;$ 

 $f_o$  = output frequency in MHz;

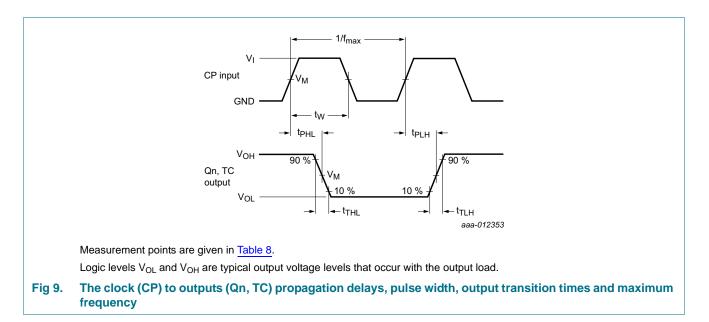
 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

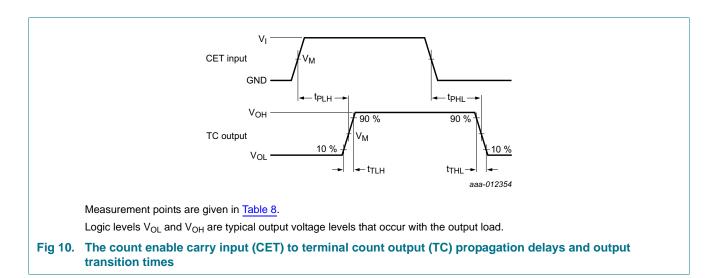
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of outputs.

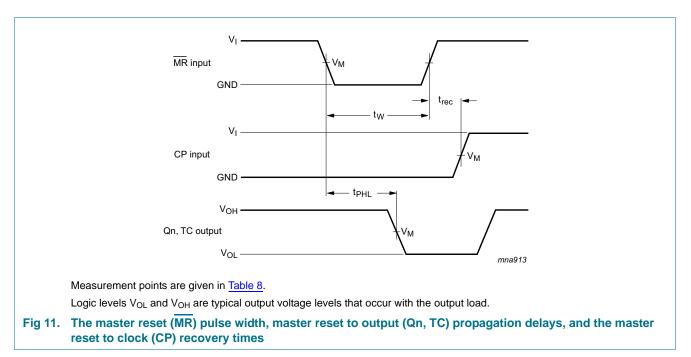
### 11. Waveforms



## 74HC161

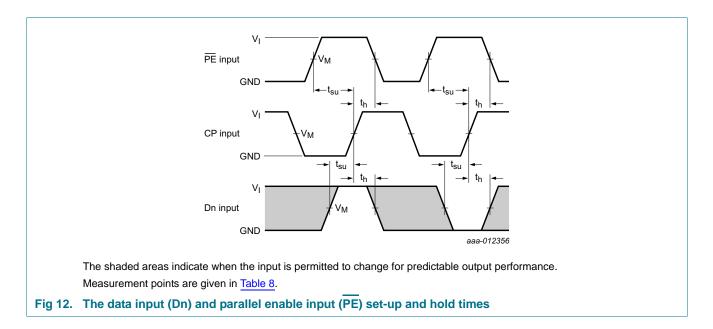
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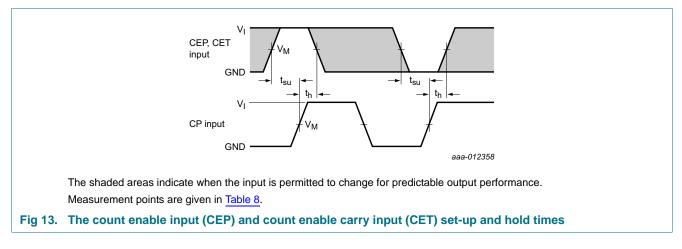




## 74HC161

### Presettable synchronous 4-bit binary counter; asynchronous reset



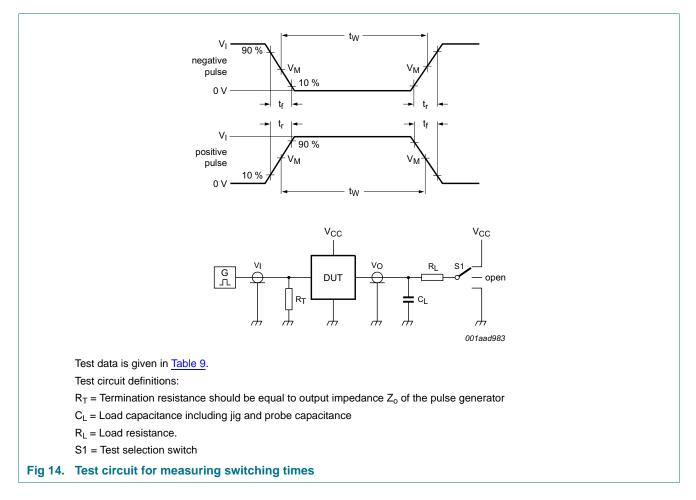


#### Table 8. Measurement points

Input	Output	
V <sub>M</sub>	VI	V <sub>M</sub>
$0.5 \times V_{CC}$	GND to V <sub>CC</sub>	$0.5 \times V_{CC}$

## 74HC161

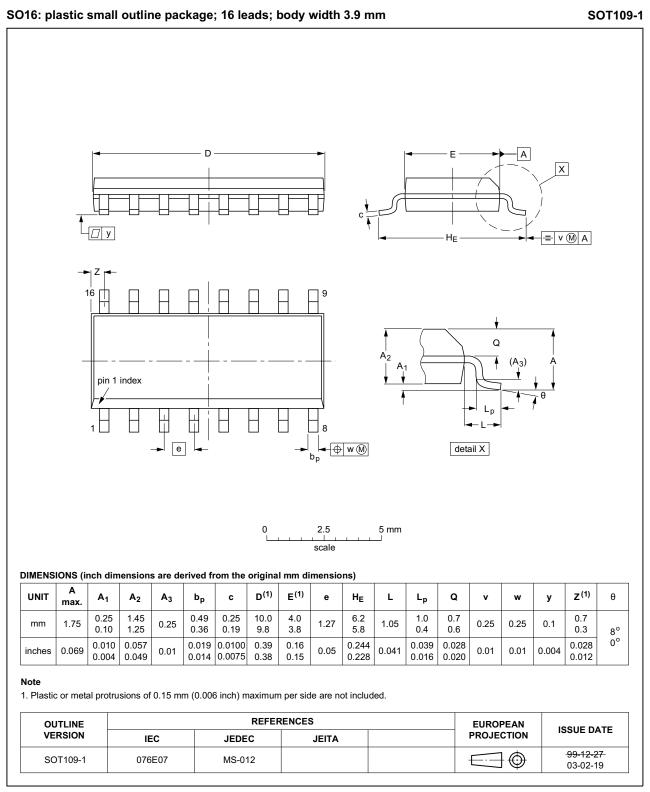
### Presettable synchronous 4-bit binary counter; asynchronous reset



#### Table 9. Test data

Input		Load	S1 position	
VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PHL</sub> , t <sub>PLH</sub>
V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open

### 12. Package outline

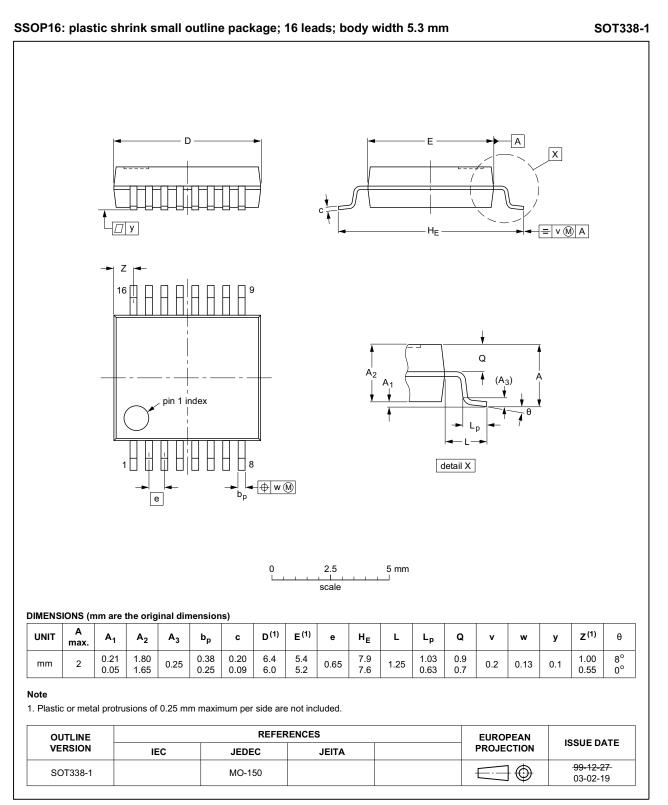


### Fig 15. Package outline SOT109-1 (SO16)

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### 74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset

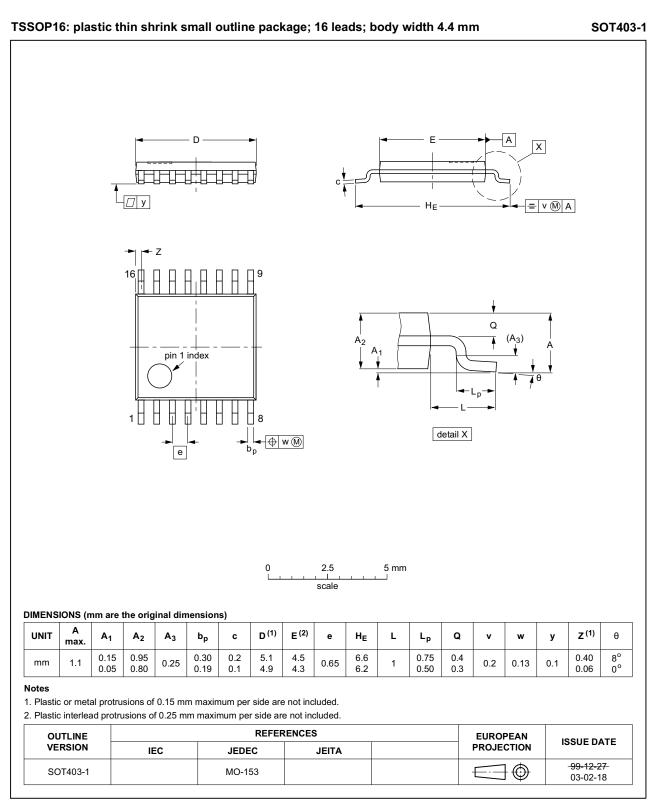


### Fig 16. Package outline SOT338-1 (SSOP16)

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### 74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset



### Fig 17. Package outline SOT403-1 (TSSOP16)

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### **13. Abbreviations**

Table 10. Abbreviations		
Acronym	Description	
CMOS	Complementary Metal-Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	

### 14. Revision history

### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC161 v.3	20170104	Product data sheet	-	74HC_HCT161 v.2	
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>				
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
	<ul> <li>Type numbers 74HCT161D, 74HCT161DB, 74HCT161PW removed.</li> </ul>				
74HC_HCT161 v.2	19901201	Product specification	-	-	

### 15. Legal information

### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

### **15.2 Definitions**

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## 74HC161

#### Presettable synchronous 4-bit binary counter; asynchronous reset

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### 74HC161

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